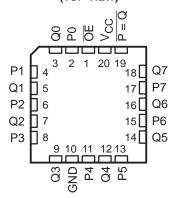
- Wide Operating Voltage Range of 2 V to 6 V
- **High-Current Outputs Drive Up To 10 LSTTL Loads**
- Low Power Consumption, 80-µA Max ICC

SN54HC688 . . . J OR W PACKAGE SN74HC688 . . . DW, N, OR PW PACKAGE (TOP VIEW)

			_
OE [1	\bigcup_{20}	v _{cc}
P0 [2	19	P = Q
Q0 [3	18	Q 7
P1 [4	17] P7
Q1 [5	16] Q6
P2 [6	15] P6
Q2 [7	14] Q5
P3 [8	13] P5
Q3 [9	12] Q4
GND [10	11] P4

- Typical $t_{pd} = 14 \text{ ns}$
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 µA Max
- **Compare Two 8-Bit Words**

SN54HC688 . . . FK PACKAGE (TOP VIEW)



description/ordering information

These identity comparators perform comparisons of two 8-bit binary or BCD words. An output-enable (\overline{OE}) input may be used to force the output to the high level.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 20	SN74HC688N	SN74HC688N
	SOIC - DW	Tube of 25	SN74HC688DW	HC688
–40°C to 85°C	301C = DW	Reel of 2000	SN74HC688DWR	110000
	TSSOP – PW	Tube of 2000	SN74HC688PWR	HC688
	1330F - FW	Reel of 250	SN74HC688PWT	ПС000
	CDIP – J	Tube of 20	SNJ54HC688J	SNJ54HC688J
–55°C to 125°C	CFP – W Tube of 85		SNJ54HC688W	SNJ54HC688W
	LCCC – FK	Tube of 55	SNJ54HC688FK	SNJ54HC688FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

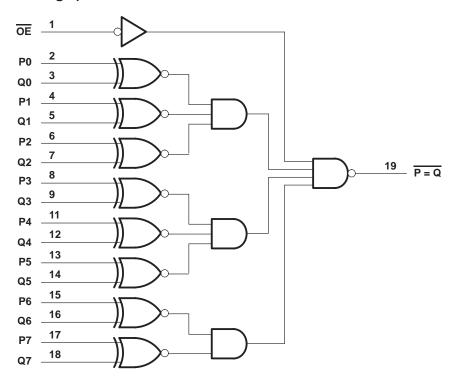
INPU'	OUTPUT	
DATA P, Q	ŌĒ	P = Q
P = Q	L	L
P > Q	Χ	Н
P < Q	X	Н
Х	Н	Н



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see	ee Note 1)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CO}	c) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})		±25 mA
Continuous current through V _{CC} or GND		±50 mA
Package thermal impedance, θ _{JA} (see Note 2):	DW package	58°C/W
	N package	69°C/W
	PW package	83°C/W
Storage temperature range, T _{stq}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 3)

			AS	SN54HC688		SN	174HC68	8	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		2	5	6	2	5	6	V
		V _{CC} = 2 V	1.5			1.5			
ViH	High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		V _{CC} = 2 V			0.5			0.5	
VIL	Low-level input voltage	V _{CC} = 4.5 V			1.35			1.35	V
		VCC = 6 V			1.8			1.8	
٧ı	Input voltage		0		VCC	0		VCC	V
٧o	Output voltage		0		VCC	0		VCC	V
		V _{CC} = 2 V			1000			1000	
t _t	Input transition (rise and fall) time	V _{CC} = 4.5 V			500			500	ns
		VCC = 6 V			400			400	
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		Vaa	Т	A = 25°C	;	SN54HC688		SN74HC688		UNIT	
PARAMETER	1251 CC	CNDITIONS	DITIONS V _{CC}		TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			2 V	1.9	1.998		1.9		1.9			
		$I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		4.4			
Voн	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V	
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84			
	I _{OH} = -	$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34			
			2 V		0.002	0.1		0.1		0.1		
		$I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1		0.1		
V _{OL}	VI = VIH or VIL		6 V		0.001	0.1		0.1		0.1	V	
		$I_{OL} = 4 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33		
			l _{OL}	$I_{OL} = 5.2 \text{ mA}$	6 V		0.15	0.26		0.4		0.33
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA	
Icc	$V_I = V_{CC}$ or 0,	I _O = 0	6 V			8		160		80	μΑ	
Ci			2 V to 6 V		3	10		10		10	pF	

SN54HC688, SN74HC688 8-BIT IDENTITY COMPARATORS

SCLS010D - DECEMBER 1982 - REVISED AUGUST 2003

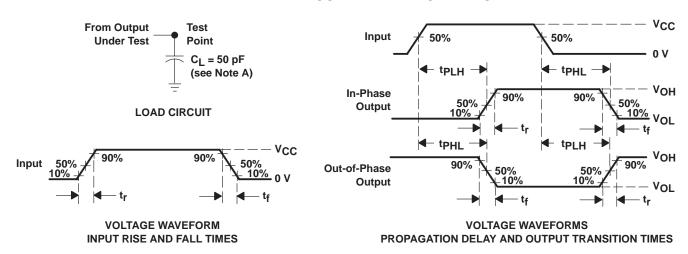
switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM TO YOU TA		T _A = 25°C		SN54HC688		SN74HC688		UNIT	
PARAMETER	(INPUT)	(OUTPUT)	TPUT) VCC		TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		113	210		313		265	
	P or Q	P = Q	4.5 V		30	42		63		53	
.			6 V		24	36		53		45	no
^t pd	ŌE P=	P = Q	2 V		66	120		179		151	ns
			P = Q	4.5 V		16	24		36		30
			6 V		14	20		30		26	
			2 V		38	75		110		95	
t _t	Any	Any	4.5 V		8	15		22		19	ns
			6 V		6	13		19		16	

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	40	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \ \Omega$, $t_f = 6 \ ns$, $t_f = 6 \ ns$.
- C. The outputs are measured one at a time with one input transition per measurement.
- D. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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